

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5352982

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ANDREAS DOEHRN	01/23/2019
RATHNAKUMAR G	01/23/2019
GURINDER BAHL	01/23/2019
AABY SIVAKUMAR	01/23/2019
RAGHAVENDRA DESHPANDE	01/23/2019
ANIL KUMAR R	01/27/2019
PRAKASH PONSHANKAARCHINNUSAMY	01/23/2019
KEFENG WANG	01/23/2019
HARTMUT VOGLER	01/23/2019
RASHMI RK	01/23/2019
PRIYANKA GUPTA	01/29/2019
SONALI JHA	01/23/2019
MAMATHA M. RAJ	01/23/2019
KUMAR RISHAV	01/31/2019
THAKUR NISHANT SINGH	01/23/2019

RECEIVING PARTY DATA

Name:	SAP SE
Street Address:	DIETMAR-HOPP-ALLEE 16
City:	WALLDORF
State/Country:	GERMANY
Postal Code:	D-69190

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16263255

CORRESPONDENCE DATA

Fax Number: (612)339-3061

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 612-373-6900

PATENT

Email:	uspto@slwip.com
Correspondent Name:	SCHWEGMAN LUNDBERG & WOESSNER/SAP
Address Line 1:	P.O. BOX 2938
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	2058.C30US1
NAME OF SUBMITTER:	DAWN R. DRAPER
SIGNATURE:	/Dawn R. Draper/
DATE SIGNED:	01/31/2019

Total Attachments: 15

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Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Andreas Doehrn**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

DATA CLOUD PLATFORM FOR DATA ENRICHMENT

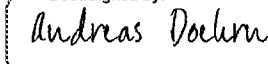
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Inventor's Signature:

DocuSigned by:

DBEA9208D4FF403...
Andreas Doehrn

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Rathnakumar G**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Rathnakumar G
6A33307F3036438...
Rathnakumar G

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Gurinder Bahl**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Gary Bahl
E5E9CAD1E0C7422...
Gurinder Bahl

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Aaby Sivakumar**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Aaby Sivakumar
92A4475095FD462...
Aaby Sivakumar

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Raghavendra Deshpande**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:

8E19C7461102452
Raghavendra Deshpande

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Anil Kumar R**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Anil Kumar R
6009C8DB3BC54DC...
Anil Kumar R

1/27/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Prakash Ponshankaarchinnusamy**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Prakash Ponshankaarchinnusamy 1/23/2019
518E46F081944C4
Prakash Ponshankaarchinnusamy

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Kefeng Wang**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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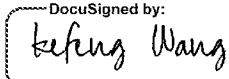
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Inventor's Signature:

DocuSigned by:

6C2C748E5120421...
Kefeng Wang

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Hartmut Vogler**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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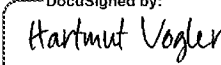
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Inventor's Signature:

DocuSigned by:

98E705A7489AC49E...
Hartmut Vogler

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Rashmi RK**,

hereby assign to

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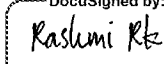
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DocuSigned by:

C9216C0203B7438...
Rashmi RK

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Priyanka Gupta**,

hereby assign to

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Inventor's Signature:

DocuSigned by:
Priyanka Gupta
8F5B43EF06E0425...
Priyanka Gupta

1/29/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Sonali Jha**,

hereby assign to

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I authorize and request the attorneys of record or the attorney filing the application to insert into this assignment the filing date and serial number of the application when known. This assignment includes the foregoing patent application or patent, as well as continuations and divisionals of said application, all legal equivalents in any country, and all patents issuing from such legal equivalents; all patents, utility models, and design registrations granted by any jurisdiction for any of said inventions and improvements; and the right to claim priority based on the filing date of the foregoing patent application or patent under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements. I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into that would conflict with this assignment. I hereby state and agree that no assignment, sale, agreement, or encumbrance has been or will be made or entered into that would conflict with this assignment. I further agree for myself and my heirs, legal representatives, and assigns to provide to the Assignee promptly upon its request and at its expense all pertinent facts and documents relating to any of said inventions and improvements or said patents and legal equivalents as may be known and accessible to me and to testify as to the same in any interference, litigation, or proceeding relating thereto; and I agree promptly to perform such lawful acts and to sign such further applications, assignments, statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Inventor's Signature:

DocuSigned by:
Sonali Jha
BA7450F6C06D466...
Sonali Jha

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Mamatha M Raj**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

DATA CLOUD PLATFORM FOR DATA ENRICHMENT

which is found in the:

US patent application filed on:

under Application No.

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Inventor's Signature:

DocuSigned by:
Mamatha M Raj
4208900F38E447A...
Mamatha M Raj

1/23/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Kumar Rishav**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

DATA CLOUD PLATFORM FOR DATA ENRICHMENT

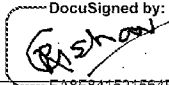
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Inventor's Signature:

DocuSigned by:

EA8F841521564B0...
Kumar Rishav

1/31/2019

Attorney Dkt. No. 2058.C30US1 / 180717US01

ASSIGNMENT

For valuable consideration, I, **Thakur Nishant Singh**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

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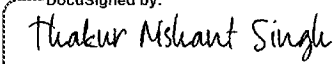
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Inventor's Signature:

DocuSigned by:

3B397195B9C14E1...
Thakur Nishant Singh

1/23/2019